5-4000 MHz Wideband Drive Amplifier



Device Features

- OIP3 = 43.5 dBm @ 900 MHz
- Gain = 21.5 dB @ 900 MHz
- Output P1 dB = 23.9 dBm @ 900 MHz
- 50 Ω Cascadable
- Lead-free/RoHS-compliant SOT-89 SMT package



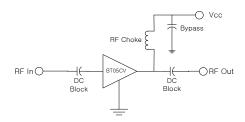
Product Description

BeRex's BT05CV is a high performance and a high dynamic range amplifier in a low cost surface mount package(SOT-89) with a RoHS -compliant, that incorporates reliable heterojunction-bipolar-transistor (HBT) devices fabricated with InGaP GaAs technology. This device is designed for use where high linearity is required and features high OIP3 and P1 with low consumption current (85mA) and requires a few external matching components such as a DC blocking capacitors on the In/Output pin, a bypass capacitor and a RF choke for the out port. All devices are 100% RF/DC tested.

Applications

- Base station Infrastructure/RFID
- Commercial/Industrial/Military wireless system

Application Circuits



^{*}external matching circuit: refer to the page 5 to 11.

Typical Performance¹

Parameter		Frequency Unit			
	900	1900	2450	3500	MHz
Gain	21.5	17.5	15.0	12.3	dB
S11	-18.0	-15.0	-17.0	-23.0	dB
S22	-15.0	-15.0	-15.0	-22.0	dB
OIP3 ²	43.5	42.0	40.5	40.0	dBm
P1dB	23.9	23.6	24.1	23.1	dBm
Noise Figure	4.4	4.2	4.3	5.4	dB

¹ Device performance $\underline{}$ measured on a BeRex evaluation board at 25°C, 50 Ω system.

 $^{^{\}rm 2}\,$ OIP3 $_$ measured with two tones at an output of 9 dBm per tone separated by 1 MHz.

	Min.	Typical	Max.	Unit
Bandwidth	5		4000	MHz
I _C @ (Vc = 5V)	75	85	95	mA
V_{C}		5.0		V
R _{TH}		50		°C/W

Absolute Maximum Ratings

Parameter	Rating	Unit
Operating Case Temperature	-40 to +85	
Storage Temperature	-55 to +155	°C
Junction Temperature	+220	°C
Operating Voltage	+6.5	V
Supply Current	180	mA
Input RF Power	23	

^{*}Operation of this device above any of these parameters may result in permanent damage.

BeRex

•website: www.berex.com

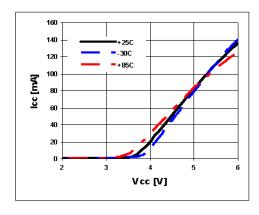
email: <u>sales@berex.com</u>

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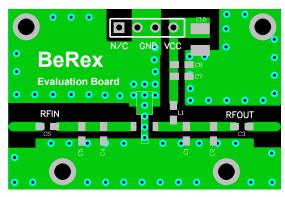
5-4000 MHz Wideband Drive Amplifier



V-I Characteristics



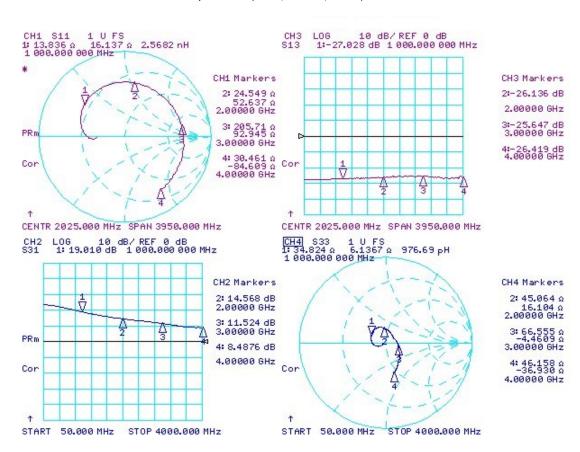
BeRex SOT89 Evaluation Board



*Dielectric constant _ 4.2 *RF pattern width 52mil *31mil thick FR4 PCB

Typical Device Data

S-parameters (Vc=5V, Ic=83mA, T=25°C)



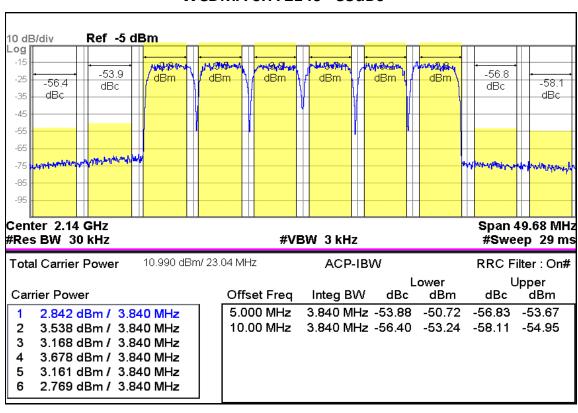


S-Parameter

(Vdevice = 5.0V, Icc = 83mA, T = 25 °C, calibrated to device leads)

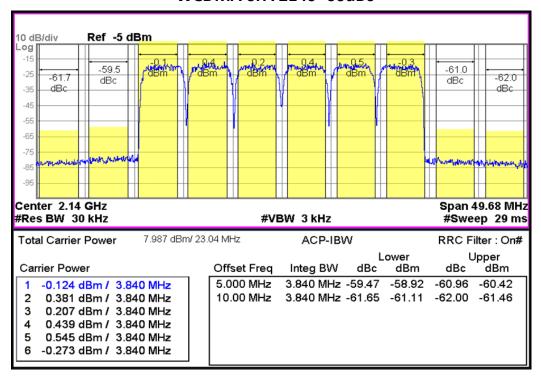
Freq	S11	S11	S21	S21	S12	S12	S22	S22
[MHz]	[Mag]	[Ang]	[Mag]	[Ang]	[Mag]	[Ang]	[Mag]	[Ang]
100	0.337	-176.993	14.904	167.360	0.041	-2.138	0.045	-150.827
500	0.482	173.684	12.408	122.325	0.042	-9.903	0.130	-166.023
1000	0.601	141.786	8.920	79.312	0.045	-24.247	0.192	153.711
1500	0.635	111.242	6.659	46.287	0.046	-38.801	0.201	124.357
2000	0.640	80.507	5.343	16.028	0.049	-54.092	0.174	97.447
2500	0.641	47.530	4.482	-13.531	0.051	-72.149	0.119	51.320
3000	0.667	10.847	3.774	-43.042	0.051	-93.463	0.147	-12.993
3500	0.706	-24.872	3.048	-71.311	0.047	-113.838	0.258	-52.979
4000	0.744	-56.383	2.650	-97.173	0.047	-134.880	0.358	-75.184

WCDMA 6FA 2140 -55dBc

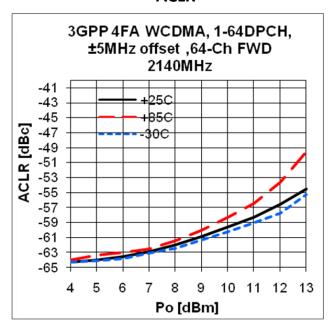




WCDMA 6FA 2140 -60dBc



ACLR



BeRex

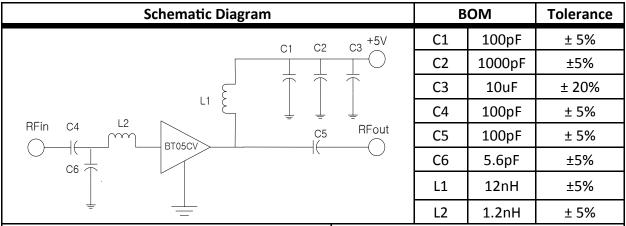
•website: www.berex.com

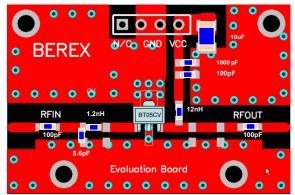
• email: sales@berex.com

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Application Circuit: 900 MHz

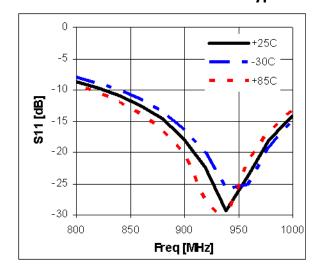


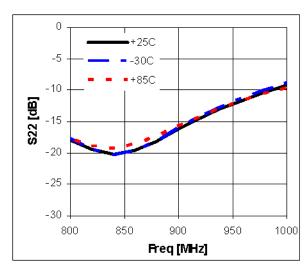


Note:

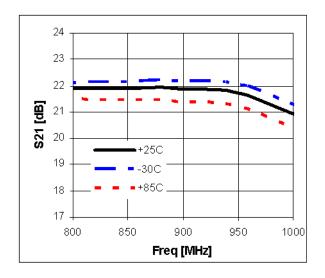
- 1. PCB: 31mil thick FR4.
- 2. Distance between the center of the series inductor(L2) and the input pin of BT05CV _ **2.0mm.**
- 3. Distance between the center of the shunt cap (C6) and the input pin of BT05CV <u>9.0mm</u>.

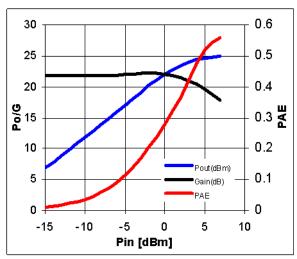
Typical Performance

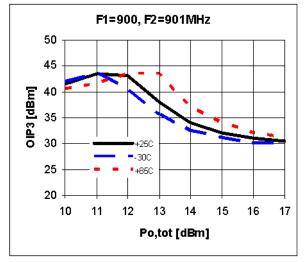


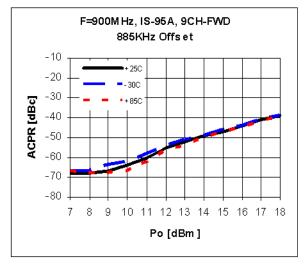








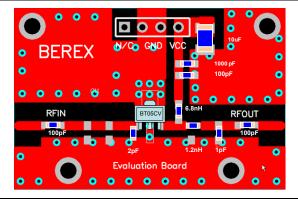






Application Circuit: 1900 MHz

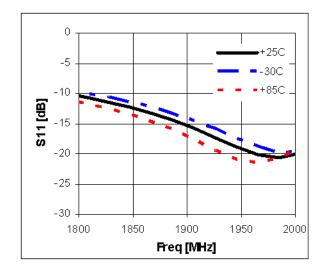
Schematic Diagram	В	ОМ	Tolerance
C1 C2 C3 ^{+5V}	C1	100pF	± 5%
	C2	1000pF	±5%
	C3	10uF	±20%
L1 &	C4	100pF	± 5%
RFin C4 L2 C5 RFout	C5	100pF	± 5%
BT05CV	C6	2pF	± 5%
. C6 ↑ C7 ↑	C7	1pF	±5%
<u> </u>	L1	6.8nH	±5%
	L2	1.2nH	± 5%

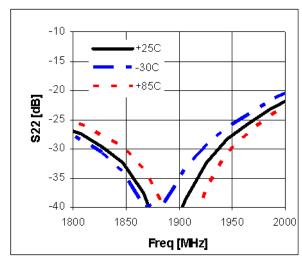


Note:

- 1. PCB: 31mil thick FR4.
- Distance between the center of the shunt cap (C6) and the input pin of BT05CV _ 1.0mm.
- 3. Distance between the center of the series inductor(L2) and the output pin of BT05CV <u>3.5mm</u>.
- Distance between the center of the shunt cap
 (C7) and the output pin of BT05CV <u>10.0mm</u>.

Typical Performance





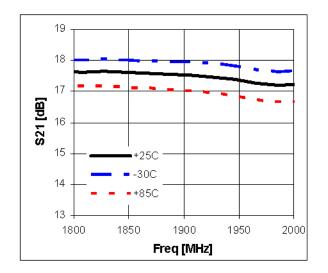
BeRex

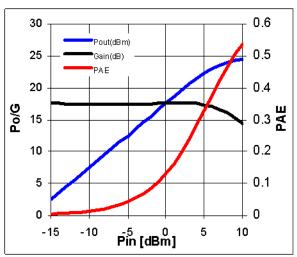
•website: www.berex.com

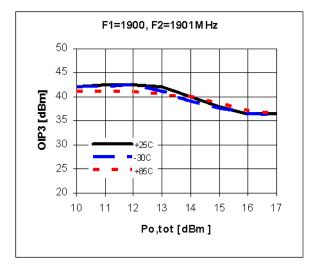
• email: sales@berex.com

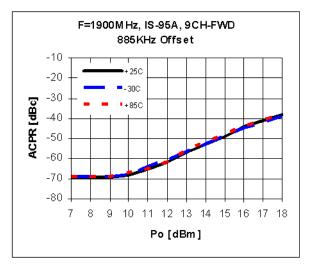
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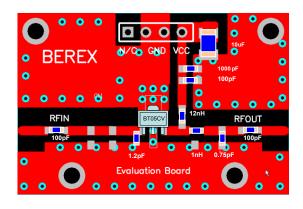






Application Circuit: 2450MHz

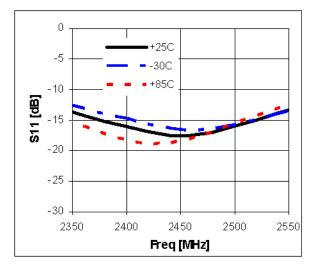
Schematic Diagram	В	ОМ	Tolerance
C1 C2 C3 +5V	C1	100pF	± 5%
	C2	1000pF	±5%
	C3	10uF	±20%
L1 £	C4	100pF	± 5%
RFin C4 L2 ± ± ± ± C5 RFout	C 5	100pF	± 5%
BT05CV T	C6	1.2pF	± 5%
C6 T C7 T	C7	0.75pF	±5%
	L1	12nH	±5%
* 	L2	1nH	± 5%

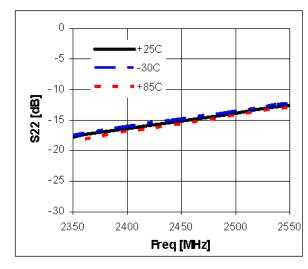


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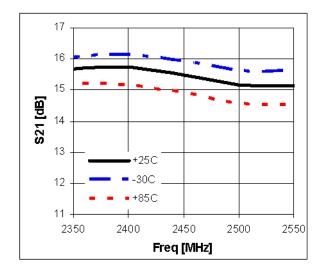
- 1. PCB: 31mil thick FR4.
- Distance between the center of the shunt cap (C6) and the input pin of BT05CV _ 0.7mm.
- 3. Distance between the center of the series inductor(L2) and the output pin of BT05CV _ <u>3.5mm.</u>
- Distance between the center of the shunt cap (C7) and the output pin of BT05CV _ <u>7.5mm</u>.

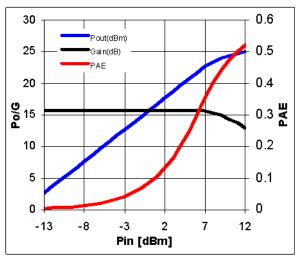
Typical Performance

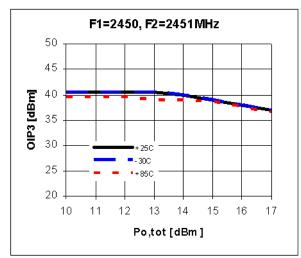


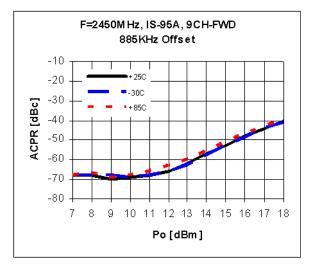








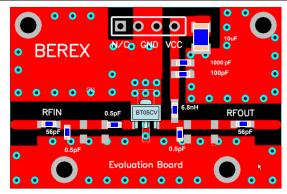






Application Circuit: 3500MHz

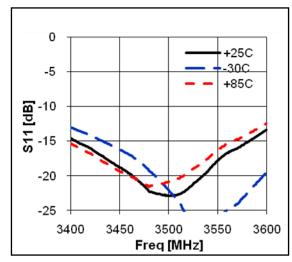
Schematic Diagram	В	ОМ	Tolerance
. FV	C1	100pF	±5%
C1 C2 C3 +5V	C2	100pF	±5%
	C3	10uF	± 20%
L1 \$	C4	56pF	± 5%
RFin C4 C7 S C5 RFout	C5	56pF	± 5%
BT05CV C5	C6	0.5pF	± 5%
C6 T C8 T	C7	0.5pF	±5%
	C8	0.5pF	±5%
	L1	6.8nH	±5%

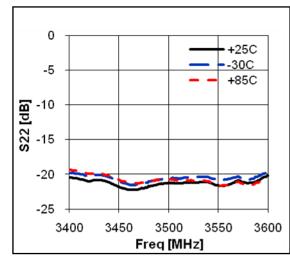


Note:

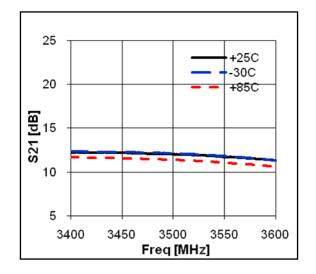
- 1. PCB: 31mil thick FR4.
- Distance between the center of the series cap
 (C7) and the input pin of BT05CV _ <u>2.0mm.</u>
- Distance between the center of the shunt cap (C7) and the input pin of BT05CV <u>10.0mm</u>.
- Distance between the center of the shunt cap (C8) and the output pin of BT05CV <u>2.3mm</u>.

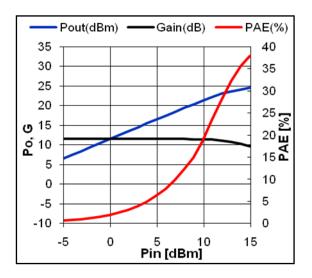
Typical Performance

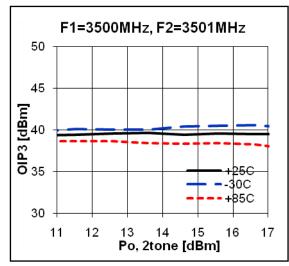






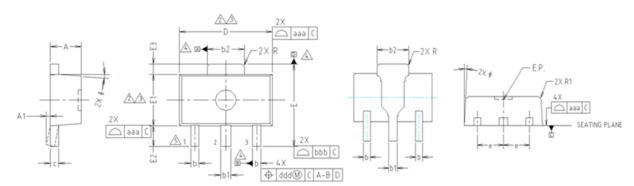








Package Outline Dimension



NOTE:

1. DIMENSIONS IN MILLIMETERS.

DIMENSION D DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 8.5mm PER END.

DIMENSION E1 DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION.

INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 8.5mm PER SIDE.

DIMENSIONS D AND E1 ARE DETERMINED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.

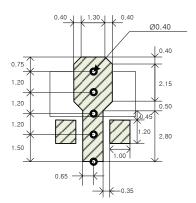
A DATUMS A, B AND D TO BE DETERMINED 8.18mm FROM THE LEAD TIP.

TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.

		MILLI	METERS	S	NOTE
SYMBOL	MINIMUM NOM		/INAL	MAXIMUM	NOIE
А	1.40	1.50		1.60	
A1	0.00		_	0.10	
Ь	0.38).42	0.48	
ь1	0.48	0).52	0.58	
b2	1.79		.82	1.87	
C	0.40	0	.42	0.46	
E E1	4.40	4	.50	4.70	2,3
E	3.70	4	.00	4.30	
E1	2.40	2	.50	2.70	2,3
E2	0.80	1	.00	1.20	
E3	0.40	0	.50	0.60	
e		1.5	O TYP.		
0			TYP.		
R		0.1	5 TYP.		
R1	-		_	0.20	
SYMBOL	TOLERANCES OF AND POSI	FORM TION	NOTE		
aaa	0.15				
bbb	0.20				
ccc	0.10				
ddd	0.10				

Suggested PCB Land Pattern and PAD Layout

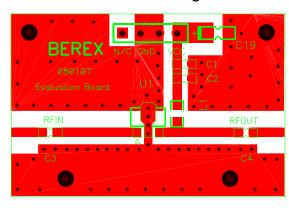
PCB Land Pattern



Note: All dimension are in millimeters

PCB lay out _ on BeRex website

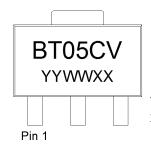
PCB Mounting



5-4000 MHz Wideband Drive Amplifier



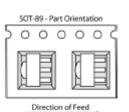
Package Marking



YY = Year, WW = Working Week, XX = Wafer No.

Tape & Reel





Packaging information:

Tape Width (mm): 12

Reel Size (inches): 7

Device Cavity Pitch (mm): 8

Devices Per Reel: 1000

Lead plating finish

100% Tin Matte finish

(All BeRex products undergoes a 1 hour, 150 degree C, Anneal bake to eliminate thin whisker growth concerns.)

MSL / ESD Rating

ESD Rating: Class 1B

Value: Passes <1000V

Test: Human Body Model (HBM)

Standard: JEDEC Standard JESD22-A114B

MSL Rating: Level 1 at +265°C convection reflow

Standard: JEDEC Standard J-STD-020

NATO CAGE code:

2 N 9 6 F
